



DMP32D9UFZ

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
-30V	5Ω @ V _{GS} = -4.5V	
	6Ω @ V _{GS} = -2.5V	-0.2A
	7Ω @ V _{GS} = -1.8V	-0.2A
	10Ω @ V _{GS} = -1.5V	

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low Package Profile, 0.42mm Maximum Package Height
- 0.62mm x 0.62mm Package Footprint
- Low On-Resistance
- Very Low Gate Threshold Voltage, -1.0V Max
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

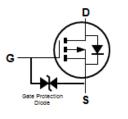
Mechanical Data

- Case: X2-DFN0606-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⁽⁴⁾
- Weight: 0.001 grams (Approximate)

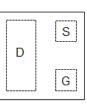




Bottom View



Equivalent Circuit



Top View Package Pin Configuration

Ordering Information (Note 4)

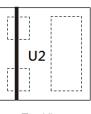
Part Number		Case	Packaging		
DMP32D9UFZ-7B		X2-DFN0606-3	10k/Tape & Reel		
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



U2 = Product Type Marking Code

Top View Bar Denotes Gate and Source Side



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±10	V
Continuous Drain Current (Note 5) V_{GS} = -4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-200 -100	mA
Pulsed Drain Current (Note 6)			I _{DM}	-700	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	Steady State	PD	390	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ extsf{ heta}JA}$	322	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	IDSS	_	_	-100	nA	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.4	_	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
		—	-	5		$V_{GS} = -4.5V, I_D = -100mA$	
		—		6		V_{GS} = -2.5V, I_{D} = -50mA	
Static Drain-Source On-Resistance	R _{DS(ON)}	—		7	Ω	V_{GS} = -1.8V, I_{D} = -20mA	
		_	_	10		$V_{GS} = -1.5V, I_{D} = -10mA$	
		_	6	—		$V_{GS} = -1.2V, I_{D} = -1mA$	
Diode Forward Voltage	V _{SD}	_	-0.75	-1.0	V	$V_{GS} = 0V, I_{S} = -10mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance Output Capacitance		—	22.5	—	pF		
		—	2.9	—	pF	[−] V _{DS} = -15V, V _{GS} = 0V, − f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	2.1	—	pF		
Total Gate Charge	Qg	_	0.35	—	nC		
Gate-Source Charge	Q _{gs}	—	0.06	—	nC	$V_{GS} = -4.5V, V_{DS} = -5V,$ $I_D = -200mA$	
Gate-Drain Charge	Q _{gd}		0.09	—	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.1	—	ns		
Turn-On Rise Time	t _R	_	2.3	_	ns	V _{DD} = -10V, V _{GS} = -4.5V,	
Turn-Off Delay Time	t _{D(OFF)}	_	19.9	_	ns	$R_G = 6\Omega$, $I_D = -200mA$	
Turn-Off Fall Time	t _F		10.5	_	ns	7	

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

7. Short duration pulse test used to minimize self-heating effect.

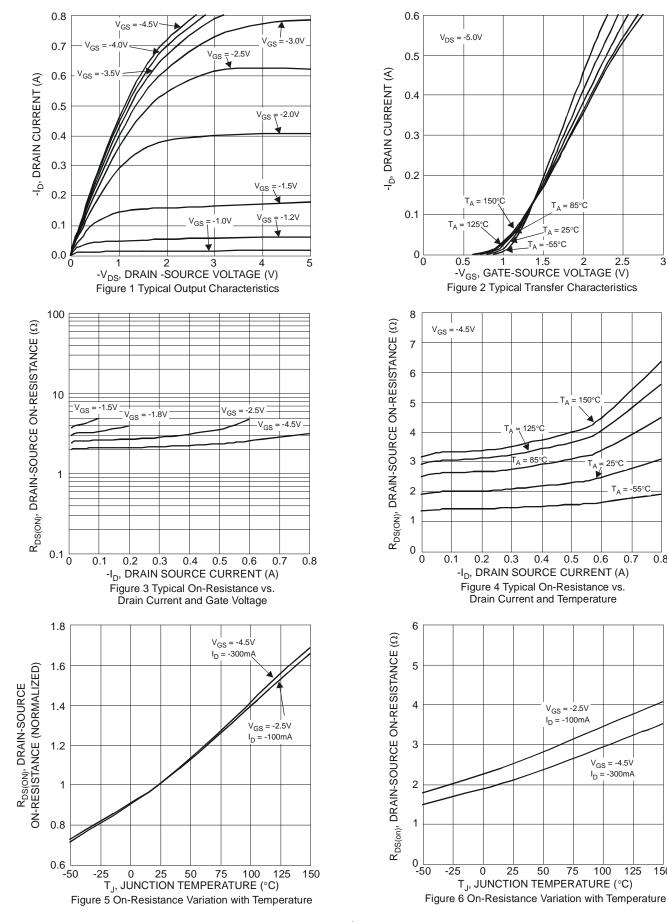
8. Guaranteed by design. Not subject to product testing.



DMP32D9UFZ

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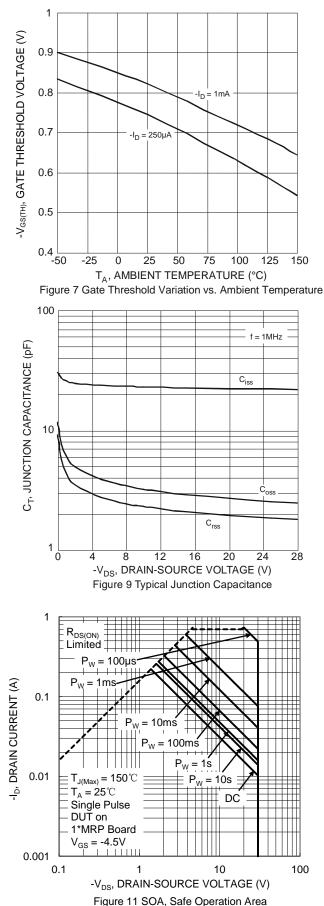
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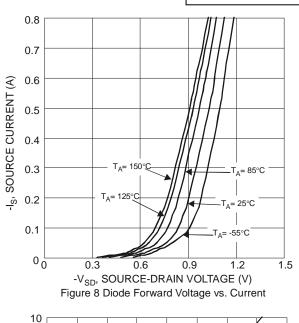


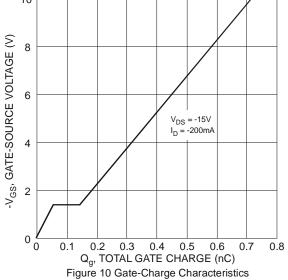
150



DMP32D9UFZ

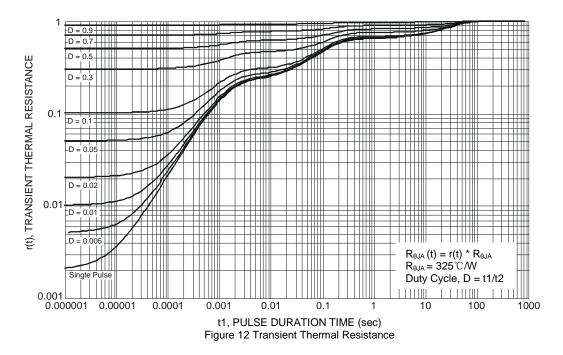










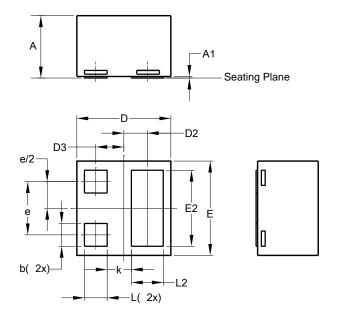




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

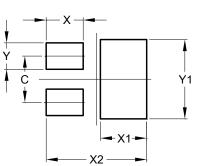
X2-DFN0606-3



	X2-DFN0606-3						
Dim	Min	Тур					
Α	0.36	0.42	0.39				
A1	0	0.05	0.02				
b	0.10	0.20	0.15				
D	0.57	0.57 0.67 0.62					
D2	0.155 BSC						
D3	0	.185 BS	С				
E	0.57	0.67	0.62				
E2	0.40	0.60	0.50				
е	0.35 BSC						
k	0.16 REF						
L	0.09	0.21	0.15				
L2	0.11	0.31	0.21				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN0606-3

Dimensions	Value (in mm)
С	0.350
Х	0.280
X1	0.350
X2	0.760
Ŷ	0.200
Y1	0.600



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